

c) Amendments to the Claims

Kindly cancel claims 1-6 without prejudice or disclaimer and amend claims 7 and 8 as follows. A detailed listing of all the claims is provided herewith.

Claims 1. - 6. (Cancelled)

7. (Currently Amended) In a ~~A~~ deposited-film formation process comprising the steps of:

generating plasma in a discharge space defined between a power-applying electrode and ~~the~~ a substrate in a vacuum chamber, the substrate being servable ~~acting~~ as an electrode disposed opposingly to the power-applying electrode; and

decomposing a material gas fed into the vacuum chamber, to form a deposited film on the substrate while the substrate is transported~~[,]~~; the improvement which comprises:

wherein;

~~the process further comprises the steps of:~~

providing the power-applying electrode with an undulation on its surface in agreement with the curving curvature of the substrate in the course of its transportation; and

disposing the power-applying electrode in the vacuum chamber.

8. (Currently Amended) In a ~~A~~ deposited-film formation process comprising the steps of:

generating plasma in a discharge space defined between a power-applying electrode and ~~the~~ a substrate in a vacuum chamber, the substrate being servable ~~acting~~ as an electrode disposed opposingly to the power-applying electrode, and

decomposing a material gas fed into the vacuum chamber, to form a deposited film on the substrate;

wherein:

preparing the inside of the vacuum chamber ~~is brought into~~ conditions for forming the deposited film[[],]; and forming the deposited film ~~is formed~~ by generating the plasma; the improvement which comprises:

after employing the power-applying electrode[[],] constituted of a plurality of sheets or a plurality of columnar members which are bundled upright with respect to the substrate; pressing the plurality of sheets or members ~~is so pressed~~ against the substrate as to come into contact with its surface to transfer a curved shape of the substrate to the surface of the power-applying electrode; and separating ~~then~~ the power-applying electrode ~~is separated~~ from the surface of the substrate.